

Pb RoHS

General Description

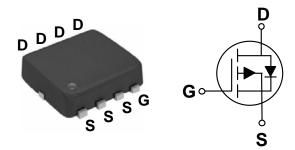
These P-Channel enhancement mode power field effect transistors are using trench DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode. These devices are well suited for high efficiency fast switching applications.

BV _{DSS}	R _{DS(ON)}	Ι _D
-30 V	11 mΩ	-35 A

Features

- -30V, -35A, R_{DS(ON)}=11m Ω @V_{GS}= -10V
- Fast switching
- Suit for -4.5V Gate Drive Applications

PPAK3X3 Pin Configuration



Applications

- MB / VGA / V_{CORE}
- POL Applications
- LED Application
- Load Switch

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	-30	V
V _{GS}	Gate-Source Voltage	±20	V
I _D	Drain Current - Continuous (T _c =25°C)	-35	Α
١D	Drain Current - Continuous (T _c =100°C)	-22.1	А
I _{DM}	Drain Current - Pulsed (NOTE 1)	-140	А
P _D	Power Dissipation (T _C =25°C)	23	W
I D	Power Dissipation - Derate above 25°C	0.18	W/°C
TJ	Operating Junction Temperature Range	-50 to 150	°C
T _{STG}	Storage Temperature Range	-50 to 150	°C
Marking Code		PC011	

Thermal Characteristics							
Symbol	Parameter	Тур.	Max	Unit			
$R_{ extsf{ heta}JA}$	Thermal Resistance Junction to Ambient		62	°C/W			
$R_{ extsf{ heta}JC}$	Thermal Resistance Junction to Case		5.4	°C/W			





Electrical Characteristics (T_J=25°C, unless otherwise noted)

Off Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} = 0V , I _D = -250uA	-30			V
1	Ines IDrain-Source Leakage Current	V_{DS} = -30V , V_{GS} = 0V , T_{J} =25°C			-1	uA
DSS		V_{DS} = -24V , V_{GS} = 0V , T_J =125°C			-10	uA
I _{GSS}	Gate-Source Leakage Current	V_{GS} = ±20V , V_{DS} = 0V			±100	nA

On Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
R _{DS(ON)}	Static Drain-Source On-Resistance	V _{GS} = -10V , I _D = -8A		9	11	mΩ
		V _{GS} = -4.5V , I _D = -6A		12	15	
V _{GS(th)}	Gate Threshold Voltage	$V_{GS}=V_{DS}$, $I_{D}=-250$ uA	-1.2	-1.6	-2.5	V
gfs	Forward Transconductance	V _{DS} = -10V , I _D = -8A		10.5		S

Dynamic and switching Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Qg	Total Gate Charge (NOTE 2 3)	$\lambda = 45\lambda + \lambda = 45\lambda$		14.6	21	
Q_gs	Gate-Source Charge (NOTE 2 \ 3)	−V _{DS} = -15V , V _{GS} = -4.5V , _I _D = -8A		4.1	6	nC
Q_gd	Gate-Drain Charge (NOTE 2 \ 3)	10- 0, (6.3	9	
T _{d(on)}	Turn-On Delay Time (NOTE 2 \ 3)			9	17	
Tr	Rise Time (NOTE 2 \ 3)	V _{DS} = -15V , V _{GEN} = -10V ,		21.8	41	nS
T _{d(off)}	Turn-Off Delay Time (NOTE 2 、3)	R_{GS} = 6 Ω , I_{D} = -1A		59.8	114	115
T _f	Fall Time (NOTE 2 \ 3)			14.4	27	
C _{iss}	Input Capacitance			1730	2510	
C _{oss}	Output Capacitance	V_{DS} = -15V , V_{GS} = 0V , F= 1MHz		180	260	pF
C _{rss}	Reverse Transfer Capacitance			125	180	

Drain-Source Diode Characteristics and Ratings

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
I _S	Continuous Source Current	$V_{G} = V_{D} = 0V$, Force Current			-30	Α
I _{SM}	Pulsed Source Current				-120	Α
V _{SD}	Diode Forward Voltage	V _{GS} = 0V , I _S = -1A			-1	V

NOTES :

1. Repetitive Rating : Pulsed width limited by maximum junction temperature.

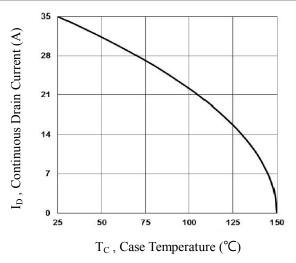
2. The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%.

3. Essentially independent of operating temperature.

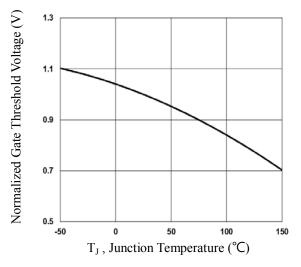


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Characteristics Curves









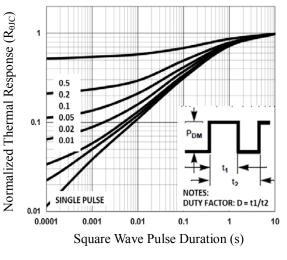


Fig.5 Normalized Transient Impedance

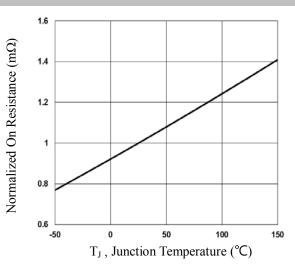


Fig.2 Normalized RDSON vs. T_J

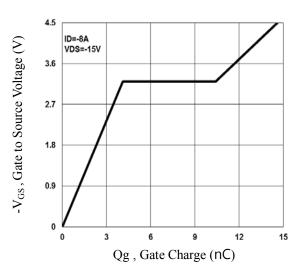


Fig.4 Gate Charge Waveform

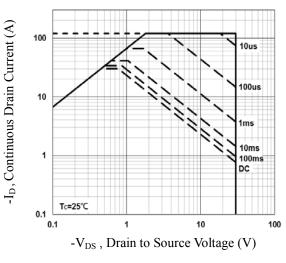


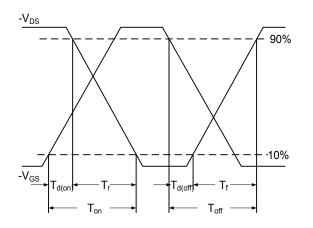
Fig.6 Maximum Safe Operation Area



Pho, RoHS

30V P-Channel MOSFETs

Characteristics Curves



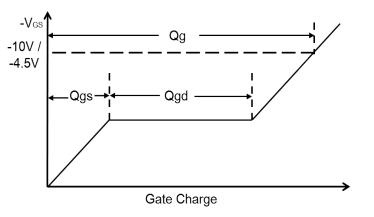


Fig.7 Switching Time Waveform



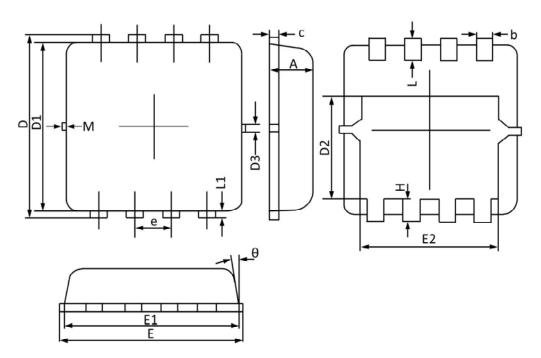


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30V P-Channel MOSFETs

Package Outline Dimensions

PPAK3X3



Symbol	Dimensions	In Millimeters	Dimension	s In Inches	
Symbol	Min	Max	Min	Max	
Α	0.700	0.800	0.028	0.031	
b	0.250	0.350	0.010	0.013	
с	0.100	0.250	0.004	0.009	
D	3.250	3.450	0.128	0.135	
D1	3.000	3.200	0.119	0.125	
D2	1.780	1.980	0.070	0.077	
D3	0.13) REF	0.005 REF		
E	3.200	3.400	0.126	0.133	
E 1	3.000	3.200	0.119	0.125	
E2	2.390	2.590	0.094	0.102	
e	0.65	0.650 BSC		BSC	
Н	0.300	0.500	0.011	0.019	
L	0.300	0.500	0.011	0.019	
L1	0.13) REF	0.005	REF	
θ	0°	12°	0°	12°	
Μ	0.15) REF	0.006 REF		



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